

## Description

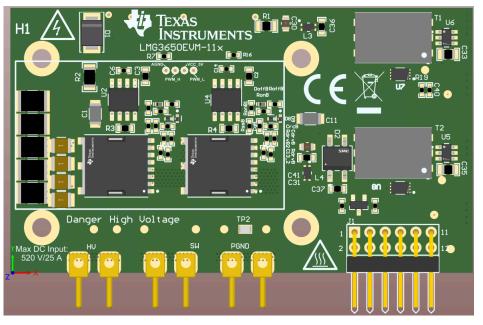
The LMG3650EVM-113 features two LMG3650R025 650V GaN FETs with an integrated driver and protection in a half-bridge configuration with all the required bias circuit and logic/power level shifting. Essential power stage and gate-driving, highfrequency current loops are fully enclosed on the board to minimize power loop parasitic inductance for reducing voltage overshoots and improving performance. The LMG3650EVM-113 is configured for a socket style external connection for easy interface with external power stages to run the LMG3650R025 in various applications. Refer to the LMG3650R025 data sheet before using this EVM.

### Features

- Two TI 650V GaN in TOLL package arranged in half bridge configuration
- Digital isolators for high side fault signal
- Isolated bias supply and bootstrap supply option
- Isolated gate driver and open component positions for layout compatibility to evaluate integrated GaN TOLL and discrete GaN TOLL
- Heat sink with fan attached for heat dissipation during testing
- Fault protection and reporting for over temperature, overcurrent, and short circuit events
- Standard daughter card pinout for compatibility with TI GaN motherboards
- Absolute maximum voltage rating of 650V

## Applications

- Merchant network and server PSU
- Merchant telecom rectifiers
- · Solar inverters and industrial motor drives
- Uninterruptible power supplies



LMG3650EVM Daughter Card

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# **1 Evaluation Module Overview**

## **1.1 Introduction**

The LMG3650EVM-113 operates as a half-bridge daughter card that can be either part of a larger custom designed system or paired with a TI GaN mother board. TI provides two mother boards (LMG342X-BB-EVM and PFC23338EVM-107) to interface with LMG3650EVM-113. LMG342X-BB-EVM is a DC/DC buck-boost converter and can support up to 4kW. PFC23338EVM-107 is an AC/DC totem-pole PFC that can support up to 3.6kW. The LMG342X-BB-EVM is designed to operate LMG3650R025 in an open-loop synchronous buck or boost converter. Probe locations are provided to measure the logic and power stage voltages. PFC23338EVM-107 is designed to operate LMG3650R025 in a closed loop totem-pole PFC.

## 1.2 Kit Contents

This kit includes one LMG3650EVM-113 daughter card with heat sink and fan as well as the appropriate high voltage and TI EVM disclaimers.

Included on the LMG3650EVM-113 daughter card:

- Two LMG3650R025 GaN ICs
- Two isolated gate drivers to enable layout compatibility and testing with discrete GaN in TOLL
- Two digital isolators for the GaN IC fault signals
- Isolated bias supply and bootstrap supply



## 2 Hardware

### 2.1 LMG3650EVM-113 Daughter Card Variants

The LMG3650R025 is part of a family of TI GaN devices in the TOLL package, offering different Rdson values and different feature functions for pin 7. The naming convention follows below.

#### LMG365 X R0 ##

| Table 2-1. Pin 7 Function |                |  |  |
|---------------------------|----------------|--|--|
| Х                         | Pin 7 Function |  |  |
| 0                         | GND            |  |  |
| 1                         | LDO5V          |  |  |
| 6                         | ZVD            |  |  |
| 7                         | ZCD            |  |  |

#### Table 2-2. Rdson

| ## | Rdson |
|----|-------|
| 25 | 25mΩ  |
| 35 | 35mΩ  |
| 70 | 70mΩ  |
|    |       |

There are two EVMs that support this family of devices.

#### Table 2-3. EVM Variants

| EVM            | Device  | EVM Style |  |  |
|----------------|---|-----------|--|--|
| LMG3650EVM-113 | LMG3650R025   | 1         |  |  |
| LMG3650EVM-114 | LMG3650R045   | 1         |  |  |
| LMG3650EVM-115 | LMG3650R070   | 1         |  |  |
| LMG3650EVM-122 | LMG3651R025, LMG3656R025,<br>LMG3657R025, LMG3651R035,<br>LMG3656R035, LMG3657R035,<br>LMG3651R070, LMG3656R070,<br>LMG3657R070 | 2         |  |  |

Style 1 EVMs support the LMG365 <u>0</u> R0## devices where the pin 7 is connected to GND. Style 2 EVMs are able to support LMG365 <u>1</u> R0##, LMG365 <u>6</u> R0##, LMG365 <u>7</u> R0## devices where pin 7 is configured for LDO5V, Zero-voltage detection (ZVD), or Zero-current detection (ZCD). The Rdson values will be interchangeable for each style EVM.

#### 2.2 LMG3650EVM-113 Daughter Card Pin Description

The LMG3650EVM-113 uses the standard TI GaN daughter card pin interface. On the style 1 EVMs, the OC pin is connected to 5V. On the style 2 EVMs, the OC pin is connected to pin 7 signal.



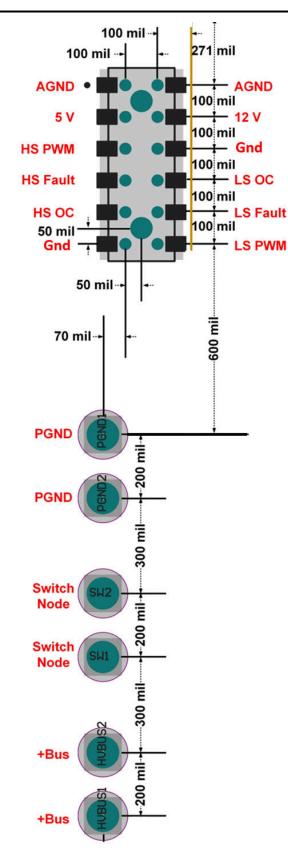


Figure 2-1. TI GaN Daughter Card Pinout



## 2.3 LMG3650EVM-113 Daughter Card Block Diagram

Style 1 EVMs include a layout compatible design with other TOLL devices that do not include an integrated gate driver or device level protections. The LMG365x family of devices are able to receive PWM signal input from a gate driver to enable this functionality.

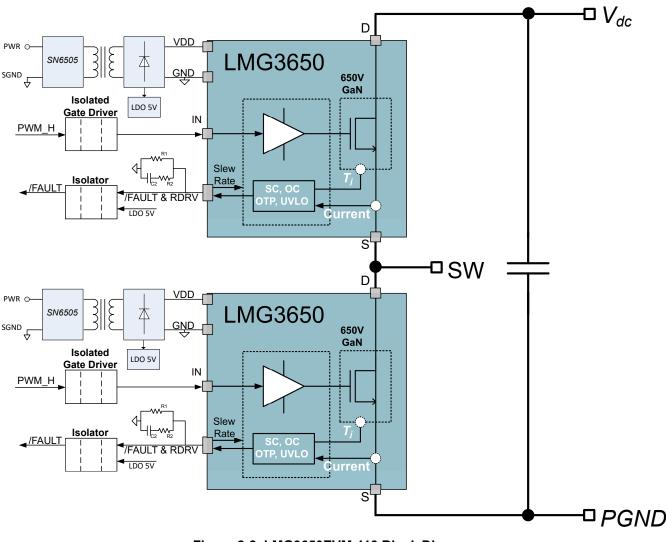


Figure 2-2. LMG3650EVM-113 Block Diagram

### 2.4 LMG3650EVM-113 Fault

The LMG3650EVM-113 outputs faults for the high side and low side devices. These are active low signals and correspond to the fault outputs outlined in the LMG3650R025 data sheet. These signals are referenced to Agnd via digital isolator on the daughter card.

### 2.5 LMG3650EVM-113 Bootstrap Mode

LMG3650EVM-113 is shipped setup with isolated bias supply for the high side and low side devices. It is also equipped with bootstrap power supply for the high side device, that is not connected. To switch from isolated bias supply to bootstrap supply:

- Remove R1
- Place 2Ω, 1206 resistor at R2
- Place 0Ω, 1206 resistor at R1



## 2.6 LMG3650EVM-113 Heat Sink

The LMG3650EVM-113 comes with a heatsink installed for heat dissipation. The LMG3650R025 is cooled through the bottom side cooling pad of the device. The heat is transferred through vias in the PCB to exposed copper on the back side of the PCB. These vias are filled and capped (IPC-4761 Type-7) so the solder doesn't fill into them creating solder voids underneath the LMG3650R025. There is a electrically isolating thermal interface material to thermally connect the heatsink to the PCB.

The heatsink has a fan attached for better thermal dissipation. The LMG342X-BB-EVM can power the fan by plugging it into header J15. For other motherboards the fan can be plugged into an eternal supply. The fan is power through 12V power supply (red – 12V, black – Ground, yellow – no connect).

## **3 Implementation Results**

### 3.1 Test Equipment

DC Voltage Source: Capable of supplying the input of the EVM up to 520V.

DC Bias Source: Capable of 12V output up to 1.5A.

**Function Generator**: Capable of 0V to 5V square wave output with adjustable duty cycle and frequency in the operating range.

**Oscilloscope**: Capable of at least 200MHz operation. A 1GHz or greater oscilloscope and probes with short ground springs are required for accurate measurements.

DC Multimeter: Capable of 650V measurement, suitable for determining operation and efficiency (if desired).

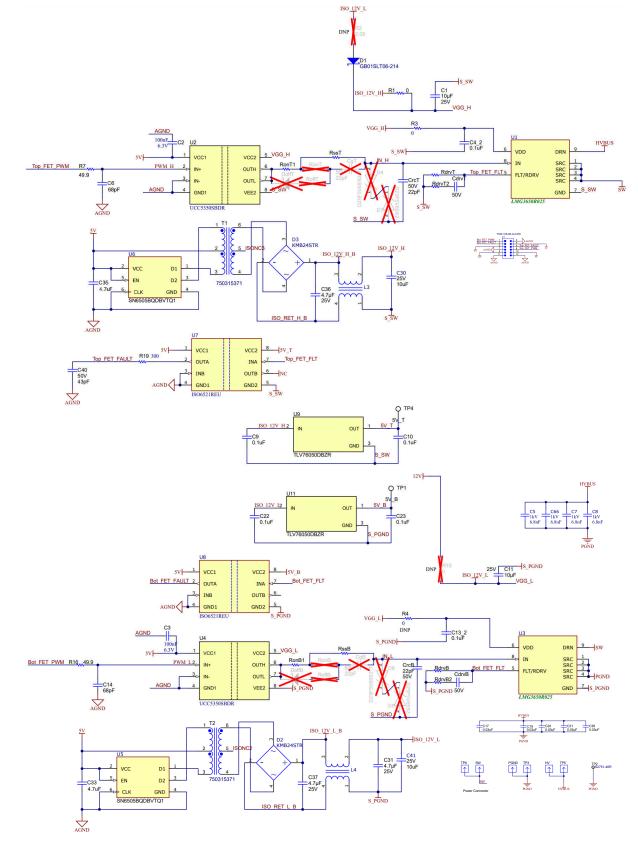
**DC Load**: Capable of 650V operation at up to 20A in current-mode operation.

**Fan**: A dedicated cooling fan is attached on the back side of the heat sink. Greater cooling is needed, an additional fan can be directed towards the EVM.

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# 4 Hardware Design Files

## 4.1 Schematics





# 4.2 PCB Layouts

Design files are included in zip folder on the EVM page on TI.com.

# 4.3 Bill of Materials (BOM)

| Designator                     | Description   | Part Number             | Quantity |
|--------------------------------|---|-------------------------|----------|
| C1, C11                        | CAP, CERM, 10µF, 25V, ±10%,<br>X7R, AEC-Q200 Grade 1, 1206                      | TMK316AB7106KLHT        | 2        |
| C2, C3                         | CAP, CERM, 0.1µF, 6.3V, ±10%,<br>X7R, 0603                                      | KGM15AR70J104KM         | 2        |
| C4_2, C9, C10, C13_2, C22, C23 | CAP, CERM, 0.1µF, 50V, ±10%,<br>X7R, 0402                                       | C1005X7R1H104K050BB     | 6        |
| C5, C7, C8, C66                | Cap Ceramic 6.8nF 1000V C0G<br>5% Pad SMD 1210 +125°C<br>Automotive T/R         | CGA6M1C0G3A682J200AE    | 4        |
| C6, C14                        | CAP, CERM, 68pF, 50V, ±5%,<br>C0G/NP0, 0402                                     | C1005C0G1H680J050BA     | 2        |
| C17, C19, C20, C21, C38        | 0.03µF ±10% 1000V (1kV)<br>Ceramic Capacitor C0G, NP0<br>1812 (4532 Metric)     | C1812C303KDGLCAUTO      | 5        |
| C30, C41                       | Cap Ceramic 10µF 25V X7S<br>10% Pad SMD 0805 +125°C<br>Automotive T/R           | CGA4J1X7S1E106K125AC    | 2        |
| C31, C36, C37                  | CAP, CERM, 4.7µF, 25V, ±10%,<br>X6S, AEC-Q200 Grade 2, 0603                     | GRT188C81E475KE13D      | 3        |
| C33, C35                       | CAP, CERM, 4.7µF, 16V, ±10%,<br>X7R, AEC-Q200 Grade 1, 0805                     | GCM21BR71C475KA73L      | 2        |
| C40                            | CAP, CERM, 43pF, 50V, ±5%,<br>C0G/NP0, AEC-Q200 Grade 1,<br>0402                | GCQ1555C1H430JB01D      | 1        |
| CdrvB, CdrvT, CrcB, CrcT       | CAP, CERM, 22pF, 50V, ±5%,<br>C0G/NP0, AEC-Q200 Grade 1,<br>0402                | GCM1555C1H220JA16D      | 4        |
| D1                             | Diode, Schottky, 650V, 1A, SMB  | GB01SLT06-214           | 1        |
| D2, D3                         | Bridge Rectifier Single Phase<br>Schottky 40V Surface Mount<br>MBS              | KMB24STR                | 2        |
| H1                             | Heat Sink, Black Anodized, 35 x<br>50mm, 20mm high, with Push Pin<br>and Spring | S05MZZ13                | 1        |
| H2                             | Thermal Interface Material  | GR80A-0H-50GY           | 1        |
| HV, PGND, SW, TP3, TP5, TP6    |   | 3621-0-32-15-00-00-08-0 | 6        |
| J1                             | Header, 100mil, 6x2, Gold, R/A,<br>TH   | TSW-106-08-G-D-RA       | 1        |
| L3, L4                         | 2 Line Common Mode Choke<br>Surface Mount 90 Ohms @<br>100MHz 400mA DCR 190mOhm | ACM2012-900-2P-T001     | 2        |



| Designator                   | Description  | Part Number        | Quantity |
|------------------------------|--|--------------------|----------|
| LBL1                         | Thermal Transfer Printable<br>Labels, 0.650" W x 0.200" H -<br>10,000 per roll | THT-14-423-10      | 1        |
| R1                           | RES, 0, 5%, 0.333 W, AEC-Q200<br>Grade 0, 0805                                 | CRCW08050000Z0EAHP | 1        |
| R3, R4                       | RES, 0, 5%, 0.1 W, AEC-Q200<br>Grade 0, 0603                                   | CRCW06030000Z0EA   | 2        |
| R7, R16                      | RES, 49.9, 1%, 0.063 W, AEC-<br>Q200 Grade 0, 0402                             | CRCW040249R9FKED   | 2        |
| R19                          | RES, 300, 5%, 0.063 W, AEC-<br>Q200 Grade 0, 0402                              | CRCW0402300RJNED   | 1        |
| RdrvB, RdrvB2, RdrvT, RdrvT2 | RES, 20 k, 5%, 0.1 W, AEC-Q200<br>Grade 0, 0402                                | ERJ-2GEJ203X       | 4        |
| RonB1, RonT1, RssB, RssT     | RES, 9.1, 5%, 0.063 W, AEC-<br>Q200 Grade 0, 0402                              | CRCW04029R10JNED   | 4        |
| T1, T2                       | Transformer, 105µH, TH   | 750315371          | 2        |
| TP2                          | Test Point, SMT  | S2751-46R          | 1        |
| U1, U3                       | LMG3650R025  | LMG3650R025        | 2        |
| U2, U4                       | 3kVRMS Single-Channel Isolated<br>Gate Drivers, D0008B (SOIC-8)                | UCC5350SBDR        | 2        |
| U5, U6                       | Transformer Driver PMIC<br>SOT-23-6  | SN6505BQDBVTQ1     | 2        |
| U7, U8                       | General Purpose Dual-Channel<br>Functional Isolators                           | ISO6521REU         | 2        |
| U9, U11                      | 100mA, 30V, Fixed-Output,<br>Linear-Voltage Regulator,<br>DBZ0003A (SOT-23-3)  | TLV76050DBZR       | 2        |



## **5** Additional Information

### 5.1 Trademarks

All trademarks are the property of their respective owners.

#### STANDARD TERMS FOR EVALUATION MODULES

- 1. Delivery: TI delivers TI evaluation boards, kits, or modules, including any accompanying demonstration software, components, and/or documentation which may be provided together or separately (collectively, an "EVM" or "EVMs") to the User ("User") in accordance with the terms set forth herein. User's acceptance of the EVM is expressly subject to the following terms.
  - 1.1 EVMs are intended solely for product or software developers for use in a research and development setting to facilitate feasibility evaluation, experimentation, or scientific analysis of TI semiconductors products. EVMs have no direct function and are not finished products. EVMs shall not be directly or indirectly assembled as a part or subassembly in any finished product. For clarification, any software or software tools provided with the EVM ("Software") shall not be subject to the terms and conditions set forth herein but rather shall be subject to the applicable terms that accompany such Software
  - 1.2 EVMs are not intended for consumer or household use. EVMs may not be sold, sublicensed, leased, rented, loaned, assigned, or otherwise distributed for commercial purposes by Users, in whole or in part, or used in any finished product or production system.
- 2 Limited Warranty and Related Remedies/Disclaimers:
  - 2.1 These terms do not apply to Software. The warranty, if any, for Software is covered in the applicable Software License Agreement.
  - 2.2 TI warrants that the TI EVM will conform to TI's published specifications for ninety (90) days after the date TI delivers such EVM to User. Notwithstanding the foregoing, TI shall not be liable for a nonconforming EVM if (a) the nonconformity was caused by neglect, misuse or mistreatment by an entity other than TI, including improper installation or testing, or for any EVMs that have been altered or modified in any way by an entity other than TI, (b) the nonconformity resulted from User's design, specifications or instructions for such EVMs or improper system design, or (c) User has not paid on time. Testing and other quality control techniques are used to the extent TI deems necessary. TI does not test all parameters of each EVM. User's claims against TI under this Section 2 are void if User fails to notify TI of any apparent defects in the EVMs within ten (10) business days after delivery, or of any hidden defects with ten (10) business days after the defect has been detected.
  - 2.3 TI's sole liability shall be at its option to repair or replace EVMs that fail to conform to the warranty set forth above, or credit User's account for such EVM. TI's liability under this warranty shall be limited to EVMs that are returned during the warranty period to the address designated by TI and that are determined by TI not to conform to such warranty. If TI elects to repair or replace such EVM, TI shall have a reasonable time to repair such EVM or provide replacements. Repaired EVMs shall be warranted for the remainder of the original warranty period. Replaced EVMs shall be warranted for a new full ninety (90) day warranty period.

# WARNING

Evaluation Kits are intended solely for use by technically qualified, professional electronics experts who are familiar with the dangers and application risks associated with handling electrical mechanical components, systems, and subsystems.

User shall operate the Evaluation Kit within TI's recommended guidelines and any applicable legal or environmental requirements as well as reasonable and customary safeguards. Failure to set up and/or operate the Evaluation Kit within TI's recommended guidelines may result in personal injury or death or property damage. Proper set up entails following TI's instructions for electrical ratings of interface circuits such as input, output and electrical loads.

NOTE:

EXPOSURE TO ELECTROSTATIC DISCHARGE (ESD) MAY CAUSE DEGREDATION OR FAILURE OF THE EVALUATION KIT; TI RECOMMENDS STORAGE OF THE EVALUATION KIT IN A PROTECTIVE ESD BAG.

3 Regulatory Notices:

3.1 United States

3.1.1 Notice applicable to EVMs not FCC-Approved:

**FCC NOTICE:** This kit is designed to allow product developers to evaluate electronic components, circuitry, or software associated with the kit to determine whether to incorporate such items in a finished product and software developers to write software applications for use with the end product. This kit is not a finished product and when assembled may not be resold or otherwise marketed unless all required FCC equipment authorizations are first obtained. Operation is subject to the condition that this product not cause harmful interference to licensed radio stations and that this product accept harmful interference. Unless the assembled kit is designed to operate under part 15, part 18 or part 95 of this chapter, the operator of the kit must operate under the authority of an FCC license holder or must secure an experimental authorization under part 5 of this chapter.

3.1.2 For EVMs annotated as FCC – FEDERAL COMMUNICATIONS COMMISSION Part 15 Compliant:

#### CAUTION

This device complies with part 15 of the FCC Rules. Operation is subject to the following two conditions: (1) This device may not cause harmful interference, and (2) this device must accept any interference received, including interference that may cause undesired operation.

Changes or modifications not expressly approved by the party responsible for compliance could void the user's authority to operate the equipment.

#### FCC Interference Statement for Class A EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class A digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference when the equipment is operated in a commercial environment. This equipment generates, uses, and can radiate radio frequency energy and, if not installed and used in accordance with the instruction manual, may cause harmful interference to radio communications. Operation of this equipment in a residential area is likely to cause harmful interference in which case the user will be required to correct the interference at his own expense.

#### FCC Interference Statement for Class B EVM devices

NOTE: This equipment has been tested and found to comply with the limits for a Class B digital device, pursuant to part 15 of the FCC Rules. These limits are designed to provide reasonable protection against harmful interference in a residential installation. This equipment generates, uses and can radiate radio frequency energy and, if not installed and used in accordance with the instructions, may cause harmful interference to radio communications. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause harmful interference to radio or television reception, which can be determined by turning the equipment off and on, the user is encouraged to try to correct the interference by one or more of the following measures:

- Reorient or relocate the receiving antenna.
- Increase the separation between the equipment and receiver.
- Connect the equipment into an outlet on a circuit different from that to which the receiver is connected.
- Consult the dealer or an experienced radio/TV technician for help.
- 3.2 Canada

3.2.1 For EVMs issued with an Industry Canada Certificate of Conformance to RSS-210 or RSS-247

#### Concerning EVMs Including Radio Transmitters:

This device complies with Industry Canada license-exempt RSSs. Operation is subject to the following two conditions:

(1) this device may not cause interference, and (2) this device must accept any interference, including interference that may cause undesired operation of the device.

#### Concernant les EVMs avec appareils radio:

Le présent appareil est conforme aux CNR d'Industrie Canada applicables aux appareils radio exempts de licence. L'exploitation est autorisée aux deux conditions suivantes: (1) l'appareil ne doit pas produire de brouillage, et (2) l'utilisateur de l'appareil doit accepter tout brouillage radioélectrique subi, même si le brouillage est susceptible d'en compromettre le fonctionnement.

#### **Concerning EVMs Including Detachable Antennas:**

Under Industry Canada regulations, this radio transmitter may only operate using an antenna of a type and maximum (or lesser) gain approved for the transmitter by Industry Canada. To reduce potential radio interference to other users, the antenna type and its gain should be so chosen that the equivalent isotropically radiated power (e.i.r.p.) is not more than that necessary for successful communication. This radio transmitter has been approved by Industry Canada to operate with the antenna types listed in the user guide with the maximum permissible gain and required antenna impedance for each antenna type indicated. Antenna types not included in this list, having a gain greater than the maximum gain indicated for that type, are strictly prohibited for use with this device.

#### Concernant les EVMs avec antennes détachables

Conformément à la réglementation d'Industrie Canada, le présent émetteur radio peut fonctionner avec une antenne d'un type et d'un gain maximal (ou inférieur) approuvé pour l'émetteur par Industrie Canada. Dans le but de réduire les risques de brouillage radioélectrique à l'intention des autres utilisateurs, il faut choisir le type d'antenne et son gain de sorte que la puissance isotrope rayonnée équivalente (p.i.r.e.) ne dépasse pas l'intensité nécessaire à l'établissement d'une communication satisfaisante. Le présent émetteur radio a été approuvé par Industrie Canada pour fonctionner avec les types d'antenne énumérés dans le manuel d'usage et ayant un gain admissible maximal et l'impédance requise pour chaque type d'antenne. Les types d'antenne non inclus dans cette liste, ou dont le gain est supérieur au gain maximal indiqué, sont strictement interdits pour l'exploitation de l'émetteur

- 3.3 Japan
  - 3.3.1 Notice for EVMs delivered in Japan: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_01.page 日本国内に 輸入される評価用キット、ボードについては、次のところをご覧ください。

https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-delivered-in-japan.html

3.3.2 Notice for Users of EVMs Considered "Radio Frequency Products" in Japan: EVMs entering Japan may not be certified by TI as conforming to Technical Regulations of Radio Law of Japan.

If User uses EVMs in Japan, not certified to Technical Regulations of Radio Law of Japan, User is required to follow the instructions set forth by Radio Law of Japan, which includes, but is not limited to, the instructions below with respect to EVMs (which for the avoidance of doubt are stated strictly for convenience and should be verified by User):

- 1. Use EVMs in a shielded room or any other test facility as defined in the notification #173 issued by Ministry of Internal Affairs and Communications on March 28, 2006, based on Sub-section 1.1 of Article 6 of the Ministry's Rule for Enforcement of Radio Law of Japan,
- 2. Use EVMs only after User obtains the license of Test Radio Station as provided in Radio Law of Japan with respect to EVMs, or
- 3. Use of EVMs only after User obtains the Technical Regulations Conformity Certification as provided in Radio Law of Japan with respect to EVMs. Also, do not transfer EVMs, unless User gives the same notice above to the transferee. Please note that if User does not follow the instructions above, User will be subject to penalties of Radio Law of Japan.

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- 2. 実験局の免許を取得後ご使用いただく。
- 3. 技術基準適合証明を取得後ご使用いただく。
- なお、本製品は、上記の「ご使用にあたっての注意」を譲渡先、移転先に通知しない限り、譲渡、移転できないものとします。 上記を遵守頂けない場合は、電波法の罰則が適用される可能性があることをご留意ください。 日本テキサス・イ

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- 3.3.3 Notice for EVMs for Power Line Communication: Please see http://www.tij.co.jp/lsds/ti\_ja/general/eStore/notice\_02.page 電力線搬送波通信についての開発キットをお使いになる際の注意事項については、次のところをご覧くださ い。https://www.ti.com/ja-jp/legal/notice-for-evaluation-kits-for-power-line-communication.html
- 3.4 European Union
  - 3.4.1 For EVMs subject to EU Directive 2014/30/EU (Electromagnetic Compatibility Directive):

This is a class A product intended for use in environments other than domestic environments that are connected to a low-voltage power-supply network that supplies buildings used for domestic purposes. In a domestic environment this product may cause radio interference in which case the user may be required to take adequate measures.

#### 4 EVM Use Restrictions and Warnings:

- 4.1 EVMS ARE NOT FOR USE IN FUNCTIONAL SAFETY AND/OR SAFETY CRITICAL EVALUATIONS, INCLUDING BUT NOT LIMITED TO EVALUATIONS OF LIFE SUPPORT APPLICATIONS.
- 4.2 User must read and apply the user guide and other available documentation provided by TI regarding the EVM prior to handling or using the EVM, including without limitation any warning or restriction notices. The notices contain important safety information related to, for example, temperatures and voltages.
- 4.3 Safety-Related Warnings and Restrictions:
  - 4.3.1 User shall operate the EVM within TI's recommended specifications and environmental considerations stated in the user guide, other available documentation provided by TI, and any other applicable requirements and employ reasonable and customary safeguards. Exceeding the specified performance ratings and specifications (including but not limited to input and output voltage, current, power, and environmental ranges) for the EVM may cause personal injury or death, or property damage. If there are questions concerning performance ratings and specifications, User should contact a TI field representative prior to connecting interface electronics including input power and intended loads. Any loads applied outside of the specified output range may also result in unintended and/or inaccurate operation and/or possible permanent damage to the EVM and/or interface electronics. Please consult the EVM user guide prior to connecting any load to the EVM output. If there is uncertainty as to the load specification, please contact a TI field representative. During normal operation, even with the inputs and outputs kept within the specified allowable ranges, some circuit components may have elevated case temperatures. These components include but are not limited to linear regulators, switching transistors, pass transistors, current sense resistors, and heat sinks, which can be identified using the information in the associated documentation. When working with the EVM, please be aware that the EVM may become very warm.
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